ON Semiconductor

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MOSFET, N-Channel, Shielded Gate, POWERTRENCH®

100 V, 50 A, 10.6 mΩ

General Description

This N-Channel POWETRENCH® MOSFET is produced using ON Semiconductor's advanced POWERTRENCH® process that incorporates Shielded Gate technology. This process has been optimized to minimize on-state resistance and yet maintain superior switching performance with best in class soft body diode.

Features

- Shielded Gate MOSFET Technology
- Max $r_{DS(on)} = 10.6 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 15 \text{ A}$
- Max $r_{DS(on)} = 15.9 \text{ m}\Omega$ at $V_{GS} = 4.5 \text{ V}$, $I_D = 12 \text{ A}$
- 50% Lower Qrr than Other MOSFET Suppliers
- Lowers Switching Noise/EMI
- MSL1 Robust Package Design
- 100% UIL Tested
- RoHS Compliant

Applications

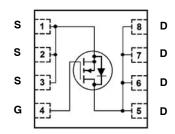
- Primary DC-DC MOSFET
- Synchronous Rectifier in DC-DC and AC-DC
- Motor Drive



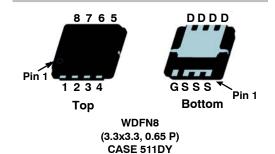
ON Semiconductor®

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ELECTRICAL CONNECTION



N-Channel MOSFET



MARKING DIAGRAM



XXXX = Device Code
A = Assembly Location
Y = Year Code
WW = Work Week Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

MOSFET MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter				Ratings	Unit
V_{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage				±20	V
I _D	Drain Current	-Continuous	T _C = 25°C	(Note 5)	50	Α
		-Continuous	T _C = 100°C	(Note 5)	32	1
		-Continuous	T _A = 25°C	(Note 1a)	10.7	1
		-Pulsed		(Note 4)	250	1
E _{AS}	Single Pulse Ava	lanche Energy		(Note 3)	73	mJ
P _D	Power Dissipatio	n	T _C = 25°C		52	W
	Power Dissipatio	n	T _A = 25°C	(Note 1a)	2.3	
T _J , T _{STG}	Operating and Storage Junction Temperature Range				-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

 R_G

Symbol	Parameter	Ratings	Unit
$R_{ heta JC}$	Thermal Resistance, Junction to Case	2.4	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	53	

PACKAGE MARKING AND ORDERING INFORMATION

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
S10L	STTFS010N10MCL	WDFN8 (3.3x3.3)	7"	12 mm	1500 Units

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Gate Resistance

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
FF CHARACT	ERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μA, referenced to 25°C		64		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
N CHARACTE	RISTICS					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 85 \mu A$	1.0	1.5	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 85 μ A, referenced to 25°C		-5.3		mV/°C
r _{DS(on)}	Static Drain to Source On	V _{GS} = 10 V, I _D = 15 A		9.1	10.6	mΩ
	Resistance	V _{GS} = 4.5 V, I _D = 12 A		13.5	15.9	
		V _{GS} = 10 V, I _D = 15 A, T _J = 125°C		15.3	17.8	
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 15 A		54		S
YNAMIC CHA	RACTERISTICS					
C _{ISS}	Input Capacitance	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V},$		1530	2150	pF
C _{OSS}	Output Capacitance	f = 1 MHz		625	875	1
C _{RSS}	Reverse Transfer Capacitance			10	18	7

0.1

1.1

2.1

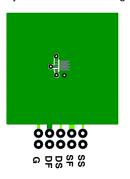
Ω

ELECTRICAL CHARACTERISTICS (T_{.I} = 25°C unless otherwise noted) (continued)

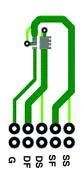
Symbol	Parameter	Test Conditions		Min	Тур	Max	Units	
ITCHING CI	HARACTERISTICS							
t _{d(ON)}	Turn – On Delay Time	V _{DD} = 50 V, I _D = 15 A			9	19	ns	
t _{rd(ON)}	Rise Time	V _{GS} = 10 V, R _{GEN} =	6 Ω		3	10		
t _{d(OFF)}	Turn – Off Delay Time	1			28	45	1	
t _f	Fall Time	1			5	10		
Qg	Total Gate Charge	V _{GS} = 0V to 10 V			22	30	nC	
Qg	Total Gate Charge	V _{GS} = 0V to 4.5 V			10			
Q _{gs}	Gate to Source Charge		V _{DD} = 50 V		4		1	
Q_{gd}	Gate to Drain "Miller" Charge	1	I _D = 15 A		3		1	
Q _{oss}	Output Charge	V _{DD} = 50 V, V _{GS} = 0 V			41		nC	
Q _{sync}	Total Gate Charge Sync	V _{DS} = 0 V, V _{GS} = 0 to 10 V			19		1	
AIN-SOUR	CE DIODE CHARACTERISTICS							
V _{SD}	Source to Drain Diode Forward	$V_{GS} = 0 \text{ V}, I_{S} = 2 \text{ A}$	(Note 2)		0.7	1.2	V	
	Voltage	V _{GS} = 0 V, I _S = 15 A	(Note 2)		0.8	1.3	1	
t _{rr}	Reverse Recovery Time	I _F = 8 A, di/dt = 300 A/μs			22	36	ns	
Q _{rr}	Reverse Recovery Charge	1			35	56	nC	
t _{rr}	Reverse Recovery Time	I _F = 8 A, di/dt = 1000 A/μs			17	30	ns	
Q _{rr}	Reverse Recovery Charge	1			79	126	nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. $R_{\theta,JA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 \times 1.5 in. board of FR-4 material. $R_{\theta,CA}$ is determined by the user's board design.



a) 53°C/W when mounted on a 1 in² pad of 2 oz copper.



b) 125°C/W when mounted on a minimum pad of 2 oz copper.

- 2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%.
- 3. E_{AS} of 73 mJ is based on starting $T_J = 25^{\circ}C$; L = 3 mH, $I_{AS} = 7$ A, $V_{DD} = 100$ V, $V_{GS} = 10$ V. 100% test at L = 0.5 mH, $I_{AS} = 13$ A.
- Pulsed I_D please refer to Figure 11 SOA graph for more details.
 Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

TYPICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

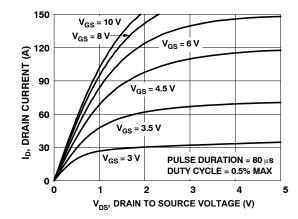


Figure 1. On Region Characteristics

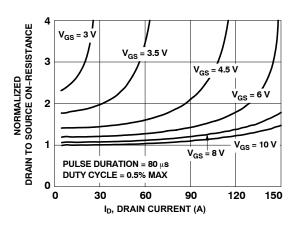


Figure 2. Normalized On–Resistance vs. Drain Current and Gate Voltage

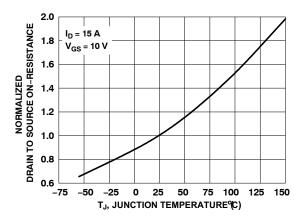


Figure 3. Normalized On Resistance vs. Junction Temperature

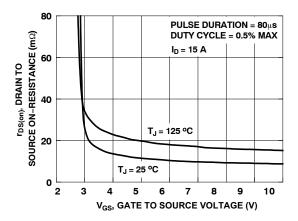


Figure 4. On-Resistance vs. Gate to Source Voltage

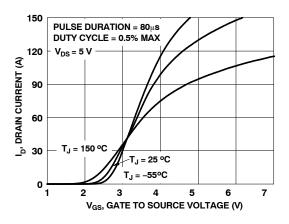


Figure 5. Transfer Characteristics

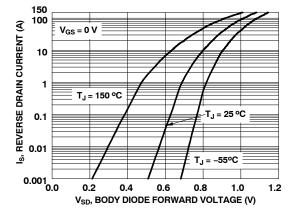


Figure 6. Source to Drain Diode Forward Voltage vs. Source Current

TYPICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

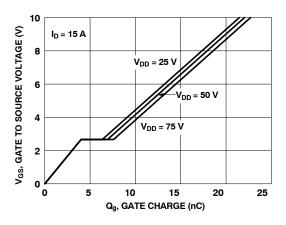


Figure 7. Gate Charge Characteristics

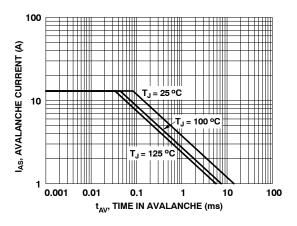


Figure 9. Unclamped Inductive Switching Capability

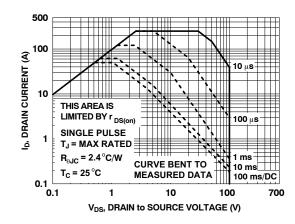


Figure 11. Forward Bias Safe Operating Area

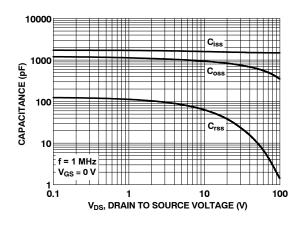


Figure 8. Capacitance vs. Drain to Source Voltage

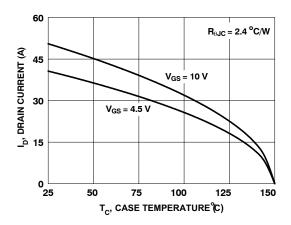


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

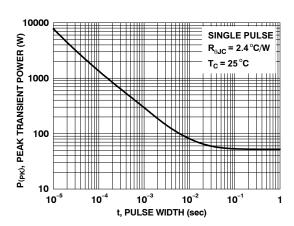


Figure 12. Single Pulse Maximum Power Dissipation

TYPICAL CHARACTERISTICS (continued)

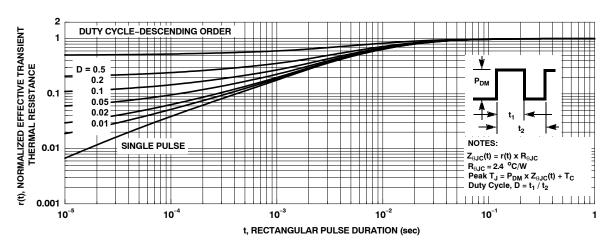
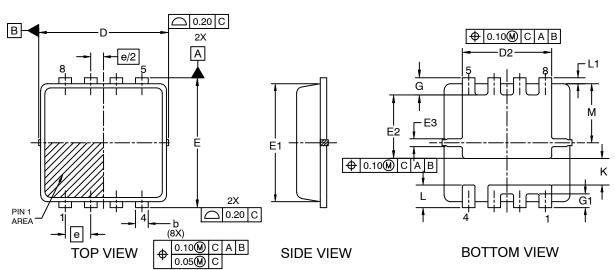


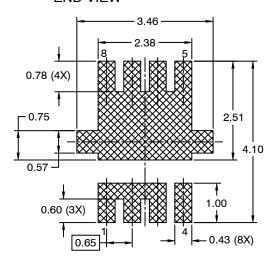
Figure 13. Junction-to-Case Transient Thermal Response Curve

PACKAGE DIMENSIONS

WDFN8 3.3x3.3, 0.65P CASE 511DY ISSUE A



END VIEW



RECOMMENDED LAND PATTERN

NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETERS
- 2. DIMENSIONS D1 & E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS NOR GATE BURRS.

DIM	MILLIMETERS				
וווטן	MIN	NOM	MAX		
Α	0.70	0.75	0.80		
A1	0.00	-	0.05		
b	0.23	0.33	0.43		
С	0.15	0.20	0.25		
D	3.20	3.30	3.40		
D1	2.95	3.13	3.30		
D2	1.98	2.20	2.40		
Е	3.20	3.30	3.40		
E1	2.80	3.00	3.15		
E2	1.40	1.60	1.80		
E3	0.15	0.25	0.40		
е	0	С			
G	0.30	0.43	0.55		
G1	0.25	0.35	0.45		
K	0.55	0.75	0.95		
L	0.35	0.52	0.65		
L1	0.06	0.15	0.30		
М	1.35	1.50	1.60		
θ	0	_	12		

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